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Contact us

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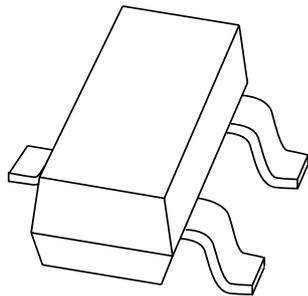
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If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via salesaddresses@nexperia.com). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

DATA SHEET



PLVA2600A series

Low-voltage avalanche regulator
double diodes

Product data sheet
Supersedes data of 1999 May 10

2001 Oct 15

Low-voltage avalanche regulator double diodes

PLVA2600A series

FEATURES

- Very low dynamic impedance at low currents: approximately $\frac{1}{20}$ of conventional series
- Hard breakdown knee
- Low noise: approximately $\frac{1}{10}$ of conventional series
- Total power dissipation: max. 250 mW
- Small tolerances of V_Z
- Working voltage range: nom. 5.0 to 6.8 V
- Non-repetitive peak reverse power dissipation: max. 30 W.

APPLICATIONS

- Low current, low power, low noise applications
- CMOS RAM back-up circuits
- Voltage stabilizers
- Voltage limiters
- Smoke detector relays.

DESCRIPTION

The PLVA2600A series consists of two high performance voltage regulator diodes with common anodes, in small SOT23 plastic SMD packages.

The series consists of PLVA2650A to PLVA2668A.

MARKING

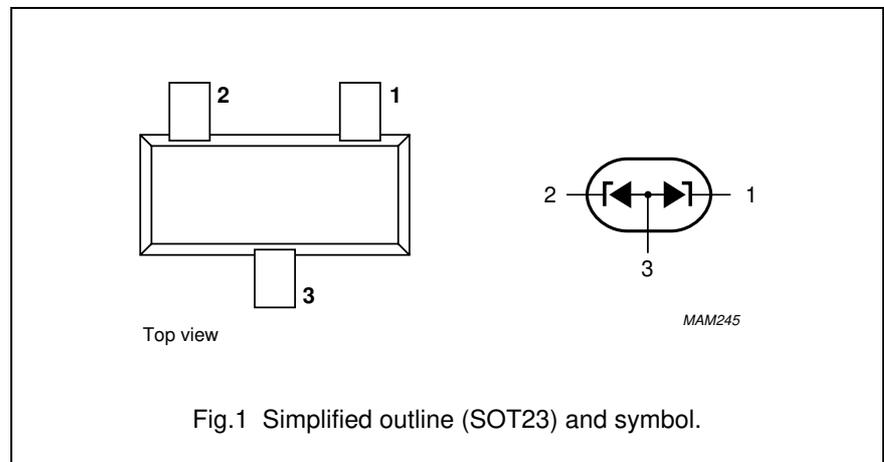
TYPE NUMBER	MARKING CODE ⁽¹⁾
PLVA2650A	*9J
PLVA2653A	*9K
PLVA2656A	*9L
PLVA2659A	*9M
PLVA2662A	*9N
PLVA2665A	*9O
PLVA2668A	*9P

Note

1. * = p : Made in Hong Kong.
* = t : Made in Malaysia.
* = W: Made in China.

PINNING

PIN	DESCRIPTION
1	cathode (k1)
2	cathode (k2)
3	common anode



Low-voltage avalanche regulator double diodes

PLVA2600A series

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_F	continuous forward current		–	250	mA
I_{ZRM}	repetitive peak working current	$t_p = 100 \mu\text{s}; \delta = 10\%$	–	250	mA
P_{ZSM}	non-repetitive peak reverse power dissipation	$t_p = 100 \mu\text{s}; T_j = 150 \text{ }^\circ\text{C}$	–	30	W
P_{tot}	total power dissipation	single diode loaded; $T_{amb} = 25 \text{ }^\circ\text{C}; \text{note 1}$	–	250	mW
		double diode loaded; $T_{amb} = 25 \text{ }^\circ\text{C}; \text{note 1}$	–	180	mW
T_{stg}	storage temperature		–65	+150	$^\circ\text{C}$
T_j	junction temperature		–	150	$^\circ\text{C}$

Note

1. Device mounted on an FR4 printed circuit-board.

Low-voltage avalanche regulator double diodes

PLVA2600A series

ELECTRICAL CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_F	forward voltage	$I_F = 10\text{ mA}$	–	–	0.9	V
V_Z	working voltage	$I_Z = 250\text{ }\mu\text{A}$	4.80	5.00	5.20	V
			5.10	5.30	5.50	V
			5.40	5.60	5.80	V
			5.70	5.90	6.10	V
			6.00	6.20	6.40	V
			6.30	6.50	6.70	V
			6.60	6.80	7.00	V
	working voltage	$I_Z = 10\text{ }\mu\text{A}$	–	4.30	–	V
			–	5.20	–	V
			–	5.51	–	V
			–	5.85	–	V
			–	6.19	–	V
			–	6.49	–	V
			–	6.80	–	V
R_Z	dynamic resistance	1 kHz superimposed; I_{ZAC} is 10% of I_{ZDC} ; $I_Z = 250\text{ }\mu\text{A}$	–	–	700	Ω
			–	–	250	Ω
			–	–	100	Ω
S_Z	temperature coefficient	$I_Z = 250\text{ }\mu\text{A}$	–	0.20	–	mV/K
			–	1.60	–	mV/K
			–	1.90	–	mV/K
			–	2.40	–	mV/K
			–	2.65	–	mV/K
			–	2.90	–	mV/K
			–	3.40	–	mV/K
I_R	reverse current	$V_R = 80\%$; V_Z nominal	–	–	20000	nA
			–	–	5000	nA
			–	–	1000	nA
			–	–	500	nA
			–	–	100	nA
			–	–	50	nA
			–	–	10	nA

Low-voltage avalanche regulator double diodes

PLVA2600A series

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT					
I_R	reverse current	$V_R = 50\%$; V_Z nominal	–	34	–	nA					
	PLVA2650A										
	PLVA2653A										
	PLVA2656A										
	PLVA2659A										
	PLVA2662A										
	PLVA2665A										
	PLVA2668A										
	reverse current	$V_R = 90\%$; V_Z nominal	–	21	–	μ A					
	PLVA2650A										
	PLVA2653A										
	PLVA2656A										
	PLVA2659A										
	PLVA2662A										
PLVA2665A											
PLVA2668A											
ΔV_Z	line regulation	$I_{LO} = 10 \mu\text{A}$; $I_{Hi} = 1 \text{ mA}$	–	–	0.1	V					
	PLVA2659A to PLVA2668A										
	PLVA2656A						$I_{LO} = 50 \mu\text{A}$; $I_{Hi} = 1 \text{ mA}$	–	–	0.1	V
	PLVA2650A						$I_{LO} = 100 \mu\text{A}$; $I_{Hi} = 1 \text{ mA}$	–	–	0.4	V
PLVA2653A	$I_{LO} = 100 \mu\text{A}$; $I_{Hi} = 1 \text{ mA}$	–	–	0.2	V						
V_n	noise voltage density	$f = 1 \text{ kHz}$; $B = 1 \text{ kHz}$; $I_Z = 250 \mu\text{A}$	–	–	1.0	$\frac{\mu\text{V}}{\sqrt{\text{Hz}}}$					

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-tp}$	thermal resistance from junction to tie-point		360	K/W
$R_{th\ j-a}$	thermal resistance from junction to ambient	note 1	500	K/W

Note

1. Device mounted on an FR4 printed circuit-board.

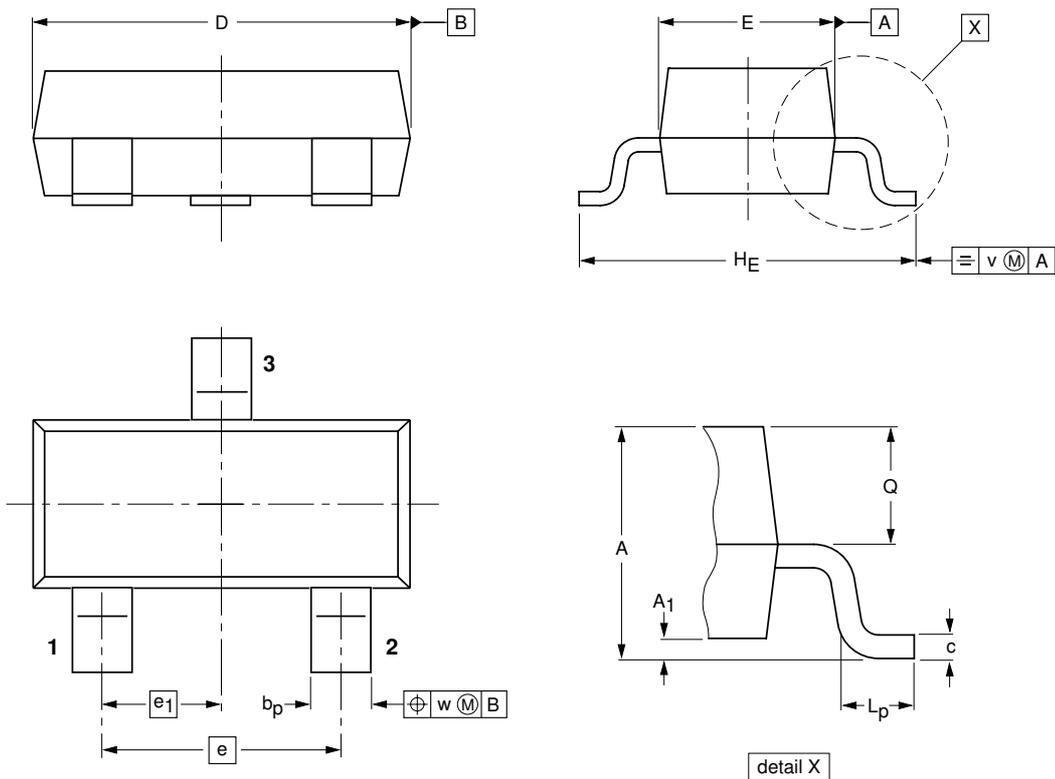
Low-voltage avalanche regulator double diodes

PLVA2600A series

PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT23



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max.	b _p	c	D	E	e	e ₁	H _E	L _p	Q	v	w
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.4 1.2	1.9	0.95	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ		
SOT23		TO-236AB			97-02-28 99-09-13

Low-voltage avalanche regulator double diodes

PLVA2600A series

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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NXP Semiconductors

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Contact information

For additional information please visit: **<http://www.nxp.com>**

For sales offices addresses send e-mail to: **salesaddresses@nxp.com**

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